Abstract—Memristors are novel devices, useful as memory at all hierarchies. These devices can also behave as logic circuits. In this paper, the IMPLY logic gate, a memristor-based logic circuit, is described. In this memristive logic family, each memristor is used as an input, output, computational logic element, and latch in different stages of the computing process. The logical state is determined by the resistance of the memristor. This logic family can be integrated within a memristor-based crossbar, commonly used for memory. In this paper, a methodology for designing this logic family is proposed. The design methodology is based on a general design flow, suitable for all deterministic memristive logic families, and includes some additional design constraints to support the IMPLY logic family. An IMPLY 8-bit full adder based on this design methodology is presented as a case study.

Index Terms—Design methodology, IMPLY, logic, memristive systems, memristor, Von Neumann architecture.

I. INTRODUCTION

MEMRISTORS [1] and memristive devices [2] are novel structures, useful in many applications. These devices are basically resistors with varying resistance, which depends on the history of the device. It can be used for memory, where the data is stored as a resistance. While memory is the common application for memristive devices, additional applications can also use memristive devices as functional blocks, such as analog circuits, neuromorphic systems, and logic circuits. Although the definition of memristive devices is broader than the definition of memristors, it is common to use the term memristor for all memristive logic families [10], [11]. In this paper, for simplicity, the terms memristor and memristive device are used interchangeably.

The use of memristors to perform logical operations has been proposed in several different ways. In some logic families, memristors are integrated with CMOS structures to perform the logical operation, while the logical values are represented by voltage levels. In [3], memristors are used as a reconfigurable switch. In [4], a hybrid memristor-CMOS logic family is proposed, memristor ratioed logic (MRL). In MRL, the memristors act as computational elements, performing OR and AND Boolean functions, while the CMOS transistors perform logical inversion and amplification of the logical voltage signals. A similar approach is proposed in [5].

Another approach for logic with memristors is to treat resistance as the logical state, where the high and low resistance are considered, respectively, as logical zero and one. For this approach, the memristors are the primary building blocks of the logic gate. Each memristor acts as an input, output, computational logic element, and latch in different stages of the computing process [6]. This approach is suitable for crossbar array architectures and can therefore be integrated within a standard memristor-based crossbar, commonly used for memory. This approach is appealing since it provides an opportunity to explore advanced computer architectures different from the classical von Neumann architecture. In these architectures, the memory can perform logical operations on the same devices that store data, i.e., performing computation inside the memory. This paper focuses on this approach.

Material implication (IMPLY logic gate) [7] is one example of a basic logical element using this approach, combining state memory and a Boolean operator. Additional logic families, which extend the IMPLY logic gate by using certain variations of a regular memristor-based crossbar, have also been proposed [8], [9] and are not considered in this paper. A specific modification of the crossbar structure is, however, presented in this paper to enhance the performance of the logic gate.

In this paper, the IMPLY logic gate is described in Section III, and a memristor-based crossbar in Section IV. A design methodology for the IMPLY logic gate is proposed in Section V. This design methodology consists of a design flow appropriate for all memristor-based logic families, as well as the IMPLY logic family. This design methodology is demonstrated by a case study of an 8-bit IMPLY full adder in Section VI. Logic inside a memristor-based memory is discussed in Section VII. This paper is concluded in Section VIII.

II. MEMRISTORS

Memristors were conceived in 1971 by Chua [1] based on fundamental principles of symmetry. Chua proposed a fourth fundamental electronic component in addition to the three already well-known fundamental electronic components: the resistor, capacitor, and inductor. The memristor has varying...
resistance (also named memristance). Changes in the memristance depend upon the history of the device (e.g., the memristance may depend on the total charge passing through the device, or alternatively, on the integral over time of the applied voltage across the ports of the device).

The theory of memristors was extended to memristive devices in 1976 [2]. Formally, a current-controlled time-invariant memristive system is represented by

\[
\frac{dx}{dt} = f(x, i) \\
v(t) = R(x, i) \cdot i(t)
\]

where \(x\) is an internal state variable, \(i(t)\) is the memristive device current, \(v(t)\) is the voltage of the memristive device, \(R(x, i)\) is the memristance, and \(t\) is time. The symbol of a memristor is illustrated in Fig. 1. Note that the polarity of the symbol defines the sign (positive or negative) of the current.

Since Hewlett-Packard announced the fabrication of a working memristor in 2008 [12], there has been increasing interest in memristors and memristive systems. New devices exhibiting memristive behavior have been announced [13], [14], and existing devices such as spin-transfer torque magnetoresistive random access memory (STT-MRAM) have been redescribed in terms of memristive systems [15]. Actually, most emerging memory technologies obey (1) and (2) and can therefore be described as memristive devices or memristors [11].

Several memristor models have been proposed to describe the behavior of physical memristors [16]–[23]. These models are deterministic and do not consider stochastic switching [40], [41]. In this paper, the threshold adaptive memristor (TEAM) model [23] is used. In the TEAM model, memristors have an adaptive nonlinearity and a current threshold. For this model, (1) becomes

\[
\frac{dx(t)}{dt} = \begin{cases} 
 k_{\text{OFF}} \cdot \left( \frac{i(t)}{i_{\text{OFF}}} - 1 \right) \cdot a_{\text{OFF}}(x), & 0 < i_{\text{OFF}} < i \\
0, & i_{\text{ON}} < i < i_{\text{OFF}} \\
 k_{\text{ON}} \cdot \left( \frac{i(t)}{i_{\text{ON}}} - 1 \right) \cdot a_{\text{ON}}(x), & i < i_{\text{ON}} < 0
\end{cases} \]  

where \(k_{\text{OFF}}\) and \(k_{\text{ON}}\) are fitting parameters, \(a_{\text{ON}}\) and \(a_{\text{OFF}}\) are the adaptive nonlinearity parameters, \(i_{\text{OFF}}\) and \(i_{\text{ON}}\) are the current threshold parameters, and \(f_{\text{ON}}(x)\) and \(f_{\text{OFF}}(x)\) are window functions. An \(I-V\) curve for the TEAM model is shown in Fig. 2 for memristors where (2) is

\[
v(t) = R_{\text{ON}} + \frac{R_{\text{OFF}} - R_{\text{ON}}}{x_{\text{OFF}} - x_{\text{ON}}} (x - x_{\text{ON}}) \cdot i(t)
\]

where \(R_{\text{ON}}\) and \(R_{\text{OFF}}\) are, respectively, the minimum and maximum resistance of the memristor, and \(x_{\text{ON}}\) and \(x_{\text{OFF}}\) are, respectively, the minimum and maximum allowed value of the internal state variable \(x\).

Memristors are nonvolatile and compatible with standard CMOS technologies [24]. These devices are fabricated in the metal layers of an integrated circuit, where the memristive effects occur in the oxide between the metal layers (e.g., in TiO\(_2\) and TaO\(_x\)) [25] or within the metal layers (e.g., in STT-MRAM). The physical model of a TiO\(_2\) memristor, proposed in [20], is shown in Fig. 3. The size of a typical memristor is relatively small, since the fabrication process is similar to processing the cross-layer via between metal layers. Memristors therefore exhibit high density and good scalability. The read and write time for these devices can be as fast as 120 picoseconds [25]. Currently, except for STT-MRAM, memristors suffer from endurance limitations, where the number of allowed writes per cell is approximately \(10^{10}\) [26]. It is believed, however, that this limit will increase to at least \(10^{15}\) [27]. Memristors may therefore solve many significant problems in the semiconductor industry, providing nonvolatile, dense, fast, and power-efficient memory.

III. IMPLY LOGIC GATE

The logic function \(p \rightarrow q\) or \(p \text{ IMPLY } q\) (also known as \(p \text{ IMPLIES } q\), material implication, and if \(p\) then \(q\)) is described in [7] and a truth table is listed in Table I. The IMPLY logic
TABLE I
TRUTH TABLE OF IMPLY FUNCTION

<table>
<thead>
<tr>
<th>Case</th>
<th>p</th>
<th>q</th>
<th>p→q</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>1</td>
</tr>
<tr>
<td>2</td>
<td>0</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>3</td>
<td>1</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>4</td>
<td>1</td>
<td>1</td>
<td>1</td>
</tr>
</tbody>
</table>

Fig. 4. IMPLY logic gate. The initial state of memristors $p$ and $q$ is the input of the logic gate and the output is the final state of the memristor $q$ after applying the voltages $V_{SET}$ and $V_{COND}$. A load resistor $R_G$ is connected to both memristors.

function together with FALSE (a function that always yields the value zero as an output) comprises a computationally complete logic structure. Since the IMPLY function can be integrated within a memristor-based crossbar, IMPLY logic provides a basic logic element for a memristor-based circuit.

A. Basic Logic Gate Operation

The proposed memristor-based IMPLY logic gate uses a resistor $R_G$ ($R_{ON} < R_G < R_{OFF}$) connected to two memristors, named $P$ and $Q$, acting as digital switches. The corresponding initial memristances $p$ and $q$ are the inputs of the gate; while the output of the gate is the final memristance of $Q$ (the result is written into the logic state $q$). Note that the memristance of both memristors changes during operation, i.e., the computation is destructive to both inputs. A schematic of an IMPLY gate is shown in Fig. 4.

The basic concept is to apply two different voltages to $P$ and $Q$, where $V_{SET}$, the applied voltage on $Q$, has a higher magnitude than $V_{COND}$, the applied magnitude on $P$ ($|V_{COND}| < |V_{SET}|$). If $p = 1$ (low resistance), the voltage on the common terminal is approximately $V_{COND}$ and the voltage on the memristor $Q$ is approximately $V_{SET} - V_{COND}$, which is sufficiently small to maintain the logic state of $q$. In the case of $p = 0$ and $q = 0$ (high resistances), the applied voltage on $Q$ is approximately $V_{SET}$ and $Q$ is switched ON ($q = 1$). In the case of $p = 0$ and $q = 1$, the logic state of $q$ is maintained. The memristance of an ideal IMPLY logic gate (zero delay time) for input cases 1 and 3 is shown in Fig. 5.

B. Analyzing the Behavior of a Logic Gate

$V_{SET}$ and $V_{COND}$, the applied voltages on $P$ and $Q$, are fixed. For any initial state, the memristor state $q$ tends to drift toward the ON state. For digital operation, the state of $q$ should either stay unchanged or switch fully ON (changing the logic state from logical zero to logical one).

The different input combinations are listed in Table I. Due to the polarity of the memristors and the applied voltages, the memristance of memristor $Q$ can only be reduced. Note that in cases 2 and 4, the initial logic state of $q$ is logical one and the logic gate output $q$ is also logical one. The gate operation, therefore, electrically reinforces the logic state of $q$ since the memristance of $Q$ is reduced.

In case 1, the initial state of $q$ is logical zero; after applying the external voltages, $q$ is switched ON. This case determines the time required to apply $V_{SET}$ and $V_{COND}$ until the logic state of $q$ reaches the desired state (above a certain level of conduction that maintains correct logical behavior). This case determines the write time of the circuit (the delay time of the logic gate).

In case 3, the initial state of $q$ is logical zero. This logic state should remain unchanged after applying $V_{SET}$ and $V_{COND}$, although the voltages tend to change the internal state of $q$ toward the ON state of logical one. This phenomenon is state drift. The logical zero state of $q$, which is the output of the gate, is electrically weaker than the input logical state of $q$ (the memristance of $Q$ after applying the voltages is lower than the initial memristance). State drift may require

Fig. 5. Behavior of an ideal IMPLY logic gate. (a) Applied voltages on both memristors $P$ and $Q$. (b) Memristance of $Q$ for cases 1 and 3. While the memristance in case 1 decreases to $R_{ON}$ within a zero write time, the memristance in case 3 does not change. (c) Current of memristor $Q$. The current in case 1 is sufficiently high to decrease the resistance of $Q$. 
refreshing the state; otherwise, repeated or prolonged sensing action may incorrectly switch the logic state of $q$. Note that the state drift phenomenon is a deterministic phenomenon. Stochastic switching [40], [41] can change the logical state of the memristors, and is not considered in this paper.

C. Speed–Robustness Tradeoff

The permissible value of the time required to apply $V_{\text{COND}}$ and $V_{\text{SET}}$ is determined from case 1. This write time is the delay time of the logic gate and determines the performance of the logic gate. Since the initial logical state of the memristors is unknown during operation (no preliminary read operation is applied), the voltages are applied at the same time for all input cases.

The state drift is determined from case 3, which depends upon the write time determined for case 1. Furthermore, any improvement in the performance due to changes in the applied voltage increases the state drift and degrades the robustness of the logic gate [28].

D. Extended Logic Functions Based on IMPLY

Any general Boolean function $f : \mathbb{B}^n \rightarrow \mathbb{B}$ can be implemented with only $n + 3$ memristors [29], where three additional memristors carry out the computation. Only two memristors are required for up to three inputs. Computation of the function is performed in steps. In each step, either FALSE is applied to one memristor, or an IMPLY is applied to two memristors, where the output is written to a memristor (which is one of the inputs of the computational IMPLY stage). This process requires a long sequence of operations depending upon the number of inputs. This methodology has been improved in [30], where only two additional memristors are used rather than three. While a general algorithm to compute any Boolean function with a minimal number of memristors has been developed [29], [30], the computational process requires a large number of functional stages, and therefore requires significant computational time.

The schematic and sequence of a two input NAND, based on a memristor-based IMPLY gate and a FALSE logic gate, are shown in Fig. 6. This NAND gate is designed to minimize the computational time and number of memristors and is comprised of three memristors. The operation of this NAND logic gate changes the function of each memristor during the computing process. Two memristors act as inputs in the initial stage, one memristor acts as the output in the last stage, and all memristors act together as a computational logic element (as a memristor-based IMPLY gate) during different stages of the computing process. This application requires three computing stages (one FALSE and two IMPLY).

The IMPLY logic gate can also be extended to a multiple input NOR logic gate [31]. In this extension, as illustrated in Fig. 7(a), $k$ input memristors $P_1, P_2, \ldots, P_k$, and a separate output memristor $Q$ are assumed. The operation of this NOR gate requires two computational stages, the first stage initializes $Q$ to logical zero ($q = 0$) and the second stage applies $V_{\text{SET}}$ and $V_{\text{COND}}$ in a manner similar to regular IMPLY. The extended NOR suffers from low fan-in since $R_G$ needs to be scaled to all possible number of inputs. To solve this issue, a different structure has been proposed where a load resistor $R_G$ is connected to every memristor and the load resistance varies, as shown in Fig. 7(b).

IV. IMPLY INSIDE A MEMRISTOR-BASED CROSSBAR

The IMPLY logic gate cannot be easily integrated with standard CMOS logic since both circuit structures are significantly different. In the IMPLY logic family, a resistance, rather than a voltage, represents the logical state. Furthermore, to operate the logic gate, a sequence of specific voltages is
applied to the memristors. The IMPLY logic gate therefore requires several computational stages (usually a different computational stage is executed during each clock cycle), and a separate mechanism to read the result of the computation and control the voltages. To integrate the IMPLY logic gate with standard voltage-based CMOS logic, a conversion mechanism is required. This mechanism includes a sense amplifier as well as additional components. The additional circuitry reduces the efficiency of integrating CMOS with a memristor-based IMPLY logic gate.

Alternatively, the IMPLY logic gate can be integrated inside a memristor-based crossbar array, commonly used for memory, where the input and output are values stored in the memory cells. This integration reduces power and provides an opportunity for novel non-von Neumann architectures. In this section, the basic structure of a memristor-based crossbar is presented, and a version of the IMPLY logic gate is illustrated.

A. Memristor-Based Crossbar

The basic structure of a memristor-based crossbar consists of two sets of parallel conductive (metal) lines. The conductive lines are perpendicular and behave as top and bottom electrodes to the memristive material, located between the lines [33]. The basic structure of a memristor-based crossbar is shown in Fig. 8. The write operation to a cell within the crossbar is achieved by applying a specific voltage to the junction, where a voltage is applied to both lines. For example, to write a logical one (low resistance), a positive voltage is applied to the column line and ground is connected to the row line (a positive voltage is applied to the memristor). To write a logical zero (high resistance), the column line is connected to ground and a positive voltage is connected to the row line (a negative voltage is applied to the memristor). These voltages are sometimes called \( V_{\text{SET}} \) (positive voltage to write a logical one, not necessarily the same voltage as in IMPLY) and \( V_{\text{RESET}} \) (negative voltage to write a logical zero). Since memristors are nonvolatile, the data does not change when no voltage is applied to the lines. The crossbar structure allows the density of the memory to be relatively high, since CMOS transistors are not used for each memory cell, but rather only to select the line. This memory structure is more than 20 times denser than DRAM [34].

The read operation of the crossbar is achieved by applying a relatively low voltage (e.g., lower than \( V_{\text{SET}} \)) to a junction and measuring the current. From Ohm’s law, the resistance of the memristor is determined from this measured current. The current measurement is usually achieved by converting the current into a voltage through a voltage divider with a known resistance \( R_{\text{pu}} \). The sensed voltage \( v_s \) is compared to a known voltage.

An undesired phenomenon in crossbars is sneak paths [35]–[38], which are undesired paths for the current flow. When a voltage is applied to a junction in the crossbar, current also flows through paths different than the desired path. These paths cross more than one memristor and add a resistance in parallel to the resistance of the memristor in the junction being read. An illustration of the sneak path phenomenon is shown in Fig. 9. This parallel resistance depends upon the stored data in the memristors in the undesired paths and changes the sensed voltage \( v_s \) from a simple voltage divider between \( R_{\text{pu}} \) and the resistance of the memristor to a voltage divider between \( R_{\text{pu}} \) and the total resistance of all memristors in all paths. A practical sensing operation should therefore consider all possible sneak paths. A schematic of a crossbar, including the read and write mechanisms, is depicted in Fig. 10. Several approaches exist to eliminate or reduce sneak paths, e.g., grounding inactive rows. In this paper, it is assumed that these approaches are used.

B. IMPLY in a Crossbar

The IMPLY logic gate can be integrated inside a crossbar, where \( P \) and \( Q \) are two memristors in the same row within the crossbar. The voltages \( V_{\text{SET}} \) and \( V_{\text{COND}} \) are the voltages of the word line, and the bit line is connected to a resistor \( R_G \). To compute different Boolean functions with more than two memristors, the memristors are placed within the same row within the crossbar. Since the IMPLY operation is destructive to \( P \) and \( Q \), if the data of the input to \( P \) is significant, a copy is assigned to a designated memristor. A schematic of a crossbar-based IMPLY logic gate is shown in Fig. 11.

V. LOGIC GATE DESIGN METHODOLOGY

In this section, design considerations and constraints for a memristor-based IMPLY logic gate in a crossbar are described.
Fig. 10. $m \times n$ memristive crossbar. The columns show the word lines and the rows identify the bit lines. Each $M_{ij}$ is a memristor. The resistance of the conductive line is $nR_w$ for the column line and $mR_w$ for the row line. $R_w$ and $R_b$ are, respectively, the word and bit line resistance.

Fig. 11. IMPLY logic gate inside a memristor-based crossbar.

It is assumed that the memristor behavior is deterministic, rather than stochastic.

A. Design Flow and Constraints

Although no complete and accurate memristor model yet exists, all of the proposed memristor models are relatively complicated and the exact behavior of a memristive logic circuit is therefore mathematically cumbersome. A need therefore exists for heuristics for designing memristive circuits. For memristor-based IMPLY logic gates, the appropriate circuit parameters ($R_G, V_{SET}, V_{COND}$, and the time to apply the voltages $T$) need to be determined under some general constraints. These constraints include minimizing power consumption (only dynamic power consumption in a memristor-based crossbar), reducing area (the number of active memristors in a crossbar and the number of transistors in the controller), lowering the delay time of the logic gate, and increasing the robustness of the circuit (by reducing resistance drift during operation for those input cases where the logical output does not change). The parasitic capacitance of the CMOS transistors connected to the crossbar and the parasitic resistance of the metal lines as well as the sneak path phenomenon also need to be considered.

A general flow for the design of a memristor-based IMPLY logic gate is shown in Fig. 12. The design of a general Boolean function is demonstrated through a case study in Section VI. After determining the topology of the circuit, the conditions at the beginning of operation need to be determined. These static conditions do not depend on the memristor model and provide necessary conditions for correct circuit behavior. Simplified memristor models use several heuristics to approximate the circuit characteristics. The TEAM model [23] is used here to estimate the circuit parameters.

B. Design Constraints and Parameter Determination for IMPLY Logic Gate

In the design of a basic IMPLY logic gate, the circuit parameters $V_{SET}, V_{COND},$ and $R_G$ and the time to apply the voltages $T$ need to be determined. The memristor parameters ($R_{ON}, R_{OFF}, k_{ON}, k_{OFF}, \alpha_{ON}, \alpha_{OFF}, i_{ON},$ and $i_{OFF}$ in the TEAM model) are fixed for a given technology.

**TABLE II**

<table>
<thead>
<tr>
<th>Case</th>
<th>$V_{P(t=0)}$</th>
<th>$V_{P(t=0)}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>$V_{SET} - V_{COND}$</td>
<td>$R_{OFF} - R_{ON}$</td>
</tr>
<tr>
<td>2</td>
<td>$V_{SET} - V_{COND}$</td>
<td>$R_{OFF} - R_{ON}$</td>
</tr>
<tr>
<td>3</td>
<td>$V_{SET} - V_{COND}$</td>
<td>$R_{OFF} - R_{ON}$</td>
</tr>
<tr>
<td>4</td>
<td>$V_{SET} - V_{COND}$</td>
<td>$R_{OFF} - R_{ON}$</td>
</tr>
</tbody>
</table>
Although difficult to compute the time evolution of the voltage at $Q$ (Fig. 4), it is possible to determine the voltage at $Q$ at the beginning of the logic gate activity. The initial applied voltage at $Q$ is different for each input case (a different initial memristance for $Q$ and $P$). The initial voltages at $P$ and $Q$ are listed in Table II under the assumptions that the memristance of the logic one and logic zero is, respectively, $R_{ON}$ and $R_{OFF}$, where $R_{OFF} \gg R_{ON}$.

From the initial applied voltages, some necessary conditions for correct logic behavior can be determined. The basic design principle is that the write (delay) time of the logic gate is determined from input case 1 (see Table II), but the circuit should also not exceed a specific state drift in input case 3.

A useful switching model is a binary memristance model [28]. Assume only two allowed memristances, $R_{ON}$ and $R_{OFF}$. A total charge $Q'$ flows through the memristor to cause the memristance $R_{OFF}$ to switch to memristance $R_{ON}$. Under these assumptions and by solving both the switching behavior in case 1 and the write time $T$ as a function of $Q'$, the circuit parameter $T$ is

$$T = \left[ \frac{R_{OFF}^2 + 2R_{OFF}R_G}{R_{OFF}V_{SET} + R_G [V_{SET} - V_{COND}]} \right] \cdot Q'. \quad (5)$$

The write time for different circuit parameters and varying $V_{SET}$ is shown in Fig. 13. Note that the logic gate is faster with a higher applied voltage or a smaller $R_{OFF}$.

Under this model, it is possible to limit the state drift (case 3 in Table II) for a fixed drift. The state drift is

$$q(T) \approx \frac{V_{SET} - R_G [V_{SET} - V_{COND}]}{R_{OFF}V_{SET} + R_G [V_{SET} - V_{COND}]} \cdot Q'. \quad (6)$$

where $q(T)$ is the total charge flowing through memristor $Q$ after time $T$, as in case 3. If the state drift is limited to a value of $Q'/4$ as the maximum state drift, after four executions of the logic gate in case 3 the state drift would change the memristive logic state of $q$. This phenomenon requires a refresh every three executions of the logic gate since the logic state would change to an invert value during the fourth time. The allowed value of $V_{SET}$ for several circuit parameters is shown in Fig. 14. Note that the state drift is more significant with a higher applied voltage, or with a smaller $R_{OFF}$. Combining Figs. 13 and 14, the tradeoff between the speed and robustness of a memristive IMPLY logic gate is illustrated in Fig. 15.

Another simple and useful memristor model assumes nonlinear behavior with a fixed threshold voltage $V_{ON}$ [28]. Under this model, for an applied voltage below $V_{ON}$, the memristance is unchanged. To produce correct logical behavior, the initial applied voltage on $Q$ must be above the threshold voltage in case 1 and below the threshold voltage in case 3. Adding this assumption to the initial applied voltage (see Table II) leads to the following two conditions on the circuit parameters:

$$R_{ON} \cdot \frac{V_{SET} - V_{ON}}{V_{ON} - [V_{SET} - V_{COND}]} < R_G$$

$$V_{SET} < \frac{R_{OFF} \cdot V_{COND}}{R_{ON}} \quad (7)$$

The allowed value for $R_G$ for several circuit parameters with varying $V_{SET}$ is shown in Fig. 16. A reasonable value of $R_G$ is the geometric mean of $R_{ON}$ and $R_{OFF}$

$$R_G = \sqrt{R_{ON} \cdot R_{OFF}} \quad (9)$$

to maintain a constant ratio between each pair of resistances, $R_{ON}$ and $R_G$, and $R_G$ and $R_{OFF}$. Other values of $R_G$ are also possible.
The parameters of the circuit are \( V_{\text{COND}} = 0.5 \) V, \( V_{\text{ON}} = 0.55 \) V, and \( R_{\text{OFF}} = 10 \) k\( \Omega \). Under the assumption of a threshold voltage \( V_{\text{OFF}} = 0 \), \( V_{\text{COND}} = 0.5 \) V, \( R_{\text{ON}} = 100 \) \( \Omega \), and \( R_{\text{OFF}} = 10 \) k\( \Omega \).

**C. Example of 1-Bit IMPLY Logic Gate**

As a specific example of applying the flow chart of Fig. 12, assume the requirement is a maximum write time (delay) of 0.5 \( \mu \)sec. Note that the actual write time of a practical memristor is significantly faster [25]. The maximum allowed state drift is 0.00001 \% \( \text{OFF} \). (0.001\% of the state drift as compared to full switching), equivalent to \( 10^6 \) executions of the logic gates before completely switching.

Assume a memristor with \( R_{\text{ON}} \) and \( R_{\text{OFF}} \), respectively, of 1 and 100 k\( \Omega \). Set one circuit parameter \( V_{\text{COND}} \) to 0.5 V. From Figs. 13 and 14, note that as \( V_{\text{SET}} \) rises, the logic gate write time \( T \) decreases and the gate response is faster; however, the state drift phenomenon is more significant.

\[
0.5 \text{ V} < V_{\text{SET}} < 50 \text{ V}.
\]  

This expression only produces a lower bound on \( V_{\text{SET}} \), since the upper bound is significantly higher than practical on-chip supply voltages. For a current-controlled memristor (e.g., TEAM model), it is unrealistic to determine an exact equivalent voltage threshold (which depends on the transient memristance of the device). A sufficient approximation for an equivalent threshold voltage is

\[
V_{\text{ON}} = i_{\text{ON}} \cdot R_{\text{OFF}}
\]

where \( V_{\text{ON}} \) is the voltage threshold, and \( i_{\text{ON}} \) is the current threshold. For a memristor with a current threshold of 7 \( \mu \)A, the equivalent voltage threshold is 0.7 volts. From (7), \( R_G \) is

\[
1.5 \text{ k}\Omega < R_G < 33.3 \text{ k}\Omega.
\]

The widely used linear ion drift memristor model [12], [23] is incompatible with IMPLY logic gates. In this model, the memristance changes linearly for any applied voltage; the state drift phenomenon is therefore significant and intolerable for IMPLY logic gates [28]. Hence, a different memristor model with a current threshold, such as the TEAM model [23], is preferable. The TEAM model accurately describes the physical behavior of memristors. The chosen circuit parameters for this example are \( R_{\text{ON}} = 1 \) k\( \Omega \), \( R_{\text{OFF}} = 100 \) k\( \Omega \), \( V_{\text{COND}} = 0.5 \) V, \( V_{\text{SET}} = 1 \) V, and \( R_G = 10 \) k\( \Omega \). SPICE simulation based on these parameters for the memristance of \( q \) are shown in Fig. 17, where the write time (delay) of this logic gate is 391.1 ns and the state drift is 0.00007\%, equivalent to about 145,000 executions before switching.

The write time (delay) and state drift for varying \( R_G \) and \( V_{\text{SET}} \) are listed in Tables III and IV. An increase in the resistance of \( R_G \) or decrease in the voltage level of \( V_{\text{SET}} \) increases the delay of the gate, but lowers the state drift phenomenon (and vice versa). The write time (delay) and state drift for different memristor parameters are listed in Table IV. An increase in the nonlinearity of the memristors (\( \alpha_{\text{ON}} \)) increases the delay of the gate, but lowers the state drift phenomenon (and vice versa). An increase in \( k_{\text{ON}} \) decreases the delay of the gate without changing the state drift phenomenon.
TABLE V

<table>
<thead>
<tr>
<th>W [μm]</th>
<th>W/L</th>
<th>CMOS Driver Resistance [Ω]</th>
<th>Voltage Drop with a Load of 100 kΩ</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.13</td>
<td>1</td>
<td>12.8k</td>
<td>11.33%</td>
</tr>
<tr>
<td>0.5</td>
<td>2.3</td>
<td>6.4k</td>
<td>6.00%</td>
</tr>
<tr>
<td>0.75</td>
<td>3.8</td>
<td>3.8k</td>
<td>3.67%</td>
</tr>
<tr>
<td>1</td>
<td>7.7</td>
<td>1.8k</td>
<td>1.33%</td>
</tr>
<tr>
<td>1.3</td>
<td>10</td>
<td>1.4k</td>
<td>0.67%</td>
</tr>
<tr>
<td>2.5</td>
<td>19.2</td>
<td>708</td>
<td>0.33%</td>
</tr>
<tr>
<td>5</td>
<td>38.5</td>
<td>349</td>
<td>0.17%</td>
</tr>
<tr>
<td>10</td>
<td>76.9</td>
<td>173</td>
<td>0.08%</td>
</tr>
<tr>
<td>20</td>
<td>153.8</td>
<td>86</td>
<td></td>
</tr>
</tbody>
</table>

TABLE VI

<table>
<thead>
<tr>
<th>W [μm]</th>
<th>W/L</th>
<th>Difference in the State</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.13</td>
<td>1</td>
<td>-0.000502%</td>
</tr>
<tr>
<td>0.5</td>
<td>2.3</td>
<td>-0.000150%</td>
</tr>
<tr>
<td>0.75</td>
<td>3.8</td>
<td>-0.000009%</td>
</tr>
<tr>
<td>1</td>
<td>7.7</td>
<td>-0.000005%</td>
</tr>
<tr>
<td>1.3</td>
<td>10</td>
<td>-0.000056%</td>
</tr>
<tr>
<td>2.5</td>
<td>19.2</td>
<td>-0.000038%</td>
</tr>
<tr>
<td>5</td>
<td>38.5</td>
<td>-0.000021%</td>
</tr>
<tr>
<td>10</td>
<td>76.9</td>
<td>-0.000011%</td>
</tr>
<tr>
<td>20</td>
<td>153.8</td>
<td>0.000006%</td>
</tr>
</tbody>
</table>

D. Variations in $V_{SET}$ and $V_{COND}$

In previous sections, it is assumed that ideal voltage sources are used for $V_{SET}$ and $V_{COND}$. Practical implementations, however, suffer from variations in the voltage level, mainly due to the resistance of the CMOS drivers. The CMOS drivers add resistance in series with the circuit and change the applied voltages. These voltage drops change the performance (as determined from input case 1) and the state drift (as determined from input case 3).

To evaluate the influence of CMOS drivers on performance and state drift, the IMPLY logic gate is simulated with similar circuit parameters as in Section V-C. The equivalent resistance of the CMOS driver for various CMOS widths is listed in Table V. The write time for different driver widths is shown in Fig. 18. For a W/L ratio of 10, the write time of the IMPLY logic gate with CMOS drivers increases by approximately 15%, as compared to ideal voltage sources. For a W/L ratio of 75, the increase in the write time is negligible (less than 1%).

To evaluate the change in the state drift phenomenon, the IMPLY logic gate is evaluated for input case 3. The difference in the state drift is listed in Table VI, exhibiting negligible difference for all W/L ratios. To overcome variations in the voltage source, the applied voltages ($V_{SET}$ and $V_{COND}$) can be increased. Alternatively, the resistance of the circuit can be increased, by increasing $R_G$ or using memristors with higher $R_{ON}$ and $R_{OFF}$ (e.g., the memristors in [42] have $R_{ON}$ of approximately 300 kΩ), or the resistance of the CMOS driver can be decreased by increasing the W/L ratio.

VI. 8-BIT IMPLY FULL ADDER: A CASE STUDY

IMPLY together with FALSE (the function that always yields zero as an output) provide a complete logical structure. While any Boolean function can be executed, an efficient procedure is required to reduce the area and computational time. In this section, a case study of an 8-bit full adder is presented to discuss several design constraints and issues for general Boolean functions. In this case study, three approaches are considered: a general algorithm [29] is considered first, which requires a long sequence and only two additional memristors. Two other specific approaches—serial and parallel—are also considered. These approaches significantly reduce the required sequence of operational steps, where the parallel approach requires more memristors for faster execution as compared to the serial approach.

A. General Boolean Functions

An algorithm to implement any general Boolean function using only IMPLY and FALSE has been proposed in [29]. This algorithm requires $n + 3$ memristors for any general Boolean function $f: B^n \rightarrow B$. While this algorithm is efficient in terms of area (the number of memristors to compute a function), it is inefficient in terms of computational time and requires $O(2kn)$ computational steps, where $n$ is the number of input memristors and $k$ is the number of additional functional memristors for the computational process. A different approach is therefore required to improve the computational time. This new approach is demonstrated in this section through a case study.

Several Boolean functions being implemented by IMPLY and FALSE are listed in Table VII. These functions are the basic building blocks of any general Boolean function. Choosing the proper building blocks and computing sequence are key when the objective is to minimize the number of
computational steps and memristors. To reduce the number of computational steps, parallelism can be exploited, where several IMPLY and FALSE operations occur during the same clock cycle. Since the operation is accomplished within the crossbar structure, the topology of the entire array needs to be considered, including possible sneak paths. Other methods for parallelism that do not suffer from sneak paths use unipolar memristors or, alternatively, insert switches between rows, which deviates from the crossbar structure. Modifying the crossbar structure to parallelize the execution is discussed in Section VI.

It is sometimes necessary to copy the value from a memory cell to other cells. The copy operation is also required when data is used multiple times, since the destruction of the input is undesired, or there is a need to transfer data to different rows within the crossbar. The copy operation is also listed in Table VII.

### B. CMOS Full Adder

The input of the full adder are two 8-bit numbers and the output is one 8-bit number $S_7, S_6, \ldots, S_0$ and 1-bit carry $C_{\text{out}}$. The basic structure of a CMOS 8-bit ripple carry adder consists of eight full adders, where the logical operation of each adder is

$$S_i = A_i \oplus B_i \oplus C_i$$

(13)

$$C_{\text{out}} = (A_i \cdot B_i) + (C_i \cdot (A_i \oplus B_i)).$$

(14)

A single CMOS 8-bit adder consists of 400 CMOS transistors, as shown in Fig. 19 for a basic full adder.

### C. IMPLY Full Adder

Several approaches exist to design an 8-bit full adder based solely on IMPLY and FALSE operations. The basic approach is to follow the algorithm proposed in [29]. Two additional approaches are considered—serial and parallel. To evaluate these approaches, the total number of memristors and the number of computation steps are compared. The general algorithm from [29] requires 712 computational steps, while the serial approach lowers the computational time to 232 computational steps with approximately the same number of memristors, and the parallel approach has the best performance of 58 computational steps but requires double the number of memristors. A comparison among the approaches is listed in Table VIII.

To execute a XOR operation, two functional memristors $M_1$ and $M_2$ are required, where the complete sequence, as listed in Table VII, is

$$A \text{ XOR } B : \ \text{FALSE}(M_1), \text{FALSE}(S), A \rightarrow S, S \rightarrow M_1 \text{ FALSE}(M_2), \text{FALSE}(S), B \rightarrow S, S \rightarrow M_2 \text{ B } \rightarrow M_1, \text{FALSE}(S), M_1 \rightarrow S \text{ A } \rightarrow M_2, M_2 \rightarrow S.$$
As compared to a conventional crossbar, the memristor-based crossbar can eliminate the sneak path phenomenon while increasing the area between the rows of the crossbar. These modifications also differ from the crossbar structure, adding connections via material implication, which can serve as memristor-based memory and, together with FALSE, provide a complete logic family. This memristive logic gate also enables non-von Neumann architectures, which may open a new era in computer architecture.

VIII. CONCLUSION

An IMPLY logic gate is a natural way to perform logic operations with memristors. This logic gate can be integrated within a memristor-based memory and, together with FALSE, provide a complete logic family. This memristive logic gate also enables non-von Neumann architectures, which may open a new era in computer architecture.

The potential benefits of memristive circuits in terms of density and power support further work in this field. The results described in this paper can be used to direct further research on device structure optimization, logic synthesis methods, array structures, and computing architectures.

REFERENCES


For an 8-bit full adder, two approaches have been examined in the case study. The serial approach executes one operation every clock cycle–IMPLY or FALSE. For the serial approach, all memristors are in the same row, as shown in Fig. 20(a). In the parallel approach, independent operations are executed during the same clock cycle, reducing the number of required computational stages. For the parallel approach, each bit in the full adder is in a different row, as shown in Fig. 20(b). The carry is passed between the different rows and the FALSE operations are simultaneously completed for several memristors. The parallel approach requires some modifications which differ from the crossbar structure, adding connections between the rows of the crossbar. These modifications also eliminate the sneak path phenomenon while increasing the area as compared to a conventional crossbar.

VII. BEYOND VON NEUMANN: LOGIC INSIDE THE MEMORY

IMPLY logic is a natural method to execute logical operations within the memristors. Memristor-based IMPLY logic has the same crossbar structure as a memristor-based memory and therefore enables the capability of performing logic operations inside the memory with the same cells used to store data. This combination enables innovative computing architectures, rather than the classical von Neumann architecture where the computing operations and the data storage are separated.

For these novel architectures, part of the computation is achieved inside the memory, with no separation with the data read and write operations. These architectures are particularly appropriate for massive parallel applications, where vast amount of data need to be processed. In von Neumann architecture for massive parallel applications, the data transfer requires a wide data bus, long latency, and consumes relatively high power. In these novel architectures, the memory and logical operations are in the same crossbar structure, almost no data transfer is required, and the latency and power are significantly reduced, although the memristor IMPLY logic delay is greater than the CMOS logic delay.

In these innovative architectures, the memristive memory serves two roles—as memory to store data and as a computational unit. The function of a specific memristor can be decided dynamically. Each memristor can act as either a memory cell or as part of an IMPLY logic gate in different stages of the operation. The effective size of the memory and the computational unit is flexible and can vary for different applications. A memristor-based memory requires a relatively complex controller that behaves as a regular memory controller and also sends control signals ($V_{SET}$ and $V_{COND}$) to the IMPLY logic gates. This novel architecture requires a new instruction set, requiring specific instructions for logic operations inside the memory.

Fig. 20. 8-bit full adder for (a) serial approach and (b) parallel approach. For the serial approach, 27 memristors are used in the same row of a standard crossbar structure. The parallel approach requires a more complex crossbar structure, where a switched connection between rows exists. Each bit execution is done in a different row using nine memristors.


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